



## ASE Inc. 2005 Q3 Earnings Release

Presented by Advanced Semiconductor Engineering, Inc. 10/26/2005

## **Safe Harbor Notice**



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This presentation contains "forward-looking statements" within the meaning of Section 27A of the Securities Act of 1933, as amended, and Section 21E of the Securities Exchange Act of 1934, as amended. Although these forward-looking statements, which may include statements regarding our future results of operations, financial condition or business prospects, are based on our own information and information from other sources we believe to be reliable, you should not place undue reliance on these forward-looking statements, which apply only as of the date of this press release. The words "anticipate", "believe", "estimate", "expect", "intend", "plan" and similar expressions, as they relate to us, are intended to identify these forward-looking statements in this press release. Our actual results of operations, financial condition or business prospects may differ materially from those expressed or implied in these forward-looking statements for a variety of reasons, including risks associated with cyclicality and market conditions in the semiconductor industry; demand for the outsourced semiconductor packaging and testing services we offer and for such outsourced services generally; the highly competitive semiconductor industry; our ability to introduce new packaging, interconnect materials and testing technologies in order to remain competitive; our ability to successfully integrate pending and future mergers and acquisitions; international business activities; our business strategy; general economic and political conditions; possible disruptions in commercial activities caused by natural or human-induced disasters, including terrorist activity and armed conflict; our future expansion plans and capital expenditures; the strained relationship between the Republic of China and the People's Republic of China; fluctuations in foreign currency exchange rates; and other factors. For a discussion of these risks and other factors, please see the documents we file from time to time with the Securities and Exchange Commission, including our 2004 Annual Report on Form 20-F filed on June 23, 2005.

## **Consolidated Income Statement**



2005 Q3 Sequential Comparison

	Sequential				
(NT\$ Million except EPS)	2005 Q3	%	2005 Q2	%	Change
Net Revenues:					
IC Packaging	15,266	68.3%	12,693	67.4%	20%
Testing	4,410	19.7%	3,752	19.9%	18%
Module Assembly	2,413	10.8%	2,283	12.1%	6%
Others	251	1.1%	91	0.5%	176%
Total Net Revenues	22,340	100.0%	18,819	100.0%	19%
Gross Profit	4,149	18.6%	2,140	11.4%	94%
Operating Profit	2,005	9.0%	(105)	-0.6%	
Pretax Income	1,734	7.8%	<mark>(10,073)</mark>	-53.5%	
Net Income after MI	1,588	7.1%	<b>(</b> 9,094)	-48.3%	
EPS <sup>1</sup>	0.35		(2.08)		
EBITDA <sup>2</sup>	5,872		2,736		

<sup>1</sup> All EPS figures are based on fully diluted number of shares EBITDA number has been adjusted for fire loss

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# **Consolidated Income Statement**



2005 Q3 YoY Comparison

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(NT\$ Million except EPS)	2005 Q3	<u> </u>	2004 Q3	%	Change	
Net Revenues:						
IC Packaging	15,266	68.3%	14,318	65.0%	7%	
Testing	4,410	19.7%	4,597	20.9%	-4%	
Module Assembly	2,413	10.8%	2,932	13.3%	-18%	
Others	251	1.1%	176	0.8%	43%	
Total Net Revenues	22,340	100.0%	22,023	100.0%	1%	
Gross Profit	4,149	18.6%	4,436	20.1%	-6%	
Operating Profit	2,005	9.0%	2,122	9.6%	-6%	
Pretax Income	1,734	7.8%	1,917	8.7%	-10%	
Net Income after MI	1,588	7.1%	1,960	8.9%	-19%	
EPS <sup>1</sup>	0.35		0.44	0.0%		
EBITDA <sup>2</sup>	5,872		6,247			

<sup>1</sup> All EPS figures are based on fully diluted number of shares EBITDA number has been adjusted for fire loss

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# Selective Balance Sheet Information

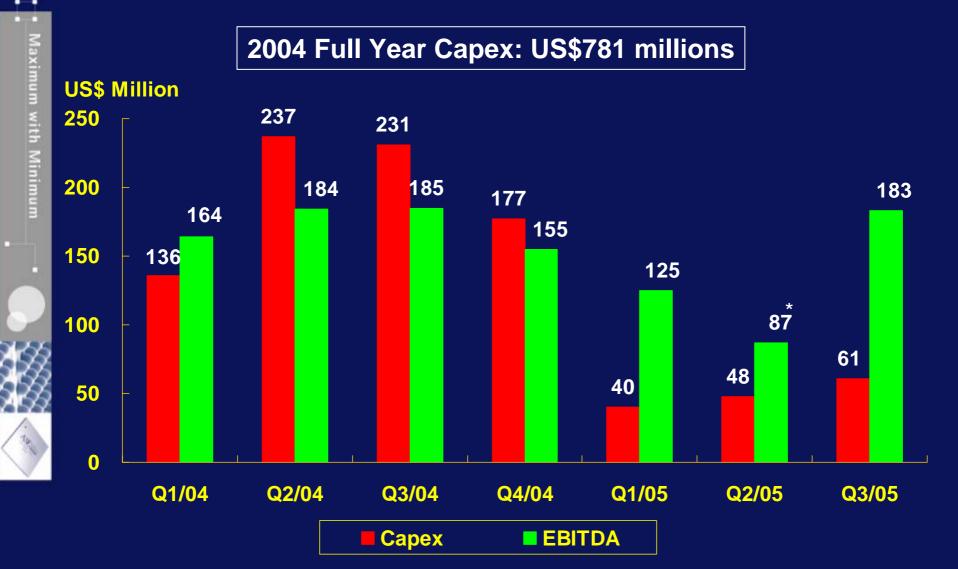


	(NT\$ Million)	Sep. 30, 2005	Jun. 30, 2005	Change			
	Cash and Cash Equivalent	9,988	9,086	9.9%			
	Short-term Investments	3,514	3,456	1.7%			
	Long-term Investments	4,802	4,816	-0.3%			
	Total Assets	130,377	125,282	4.1%			
	ST Bank Debt - Revolving Credit	6,400	6,204	3.2%			
	- Current Portion of LT Debt	6,523	4,461	46.2%			
	Bonds Payable within 1 year	0	0				
	LT Bank Debt	35,338	38,311	-7.8%			
s	LT Bonds Payable	9,358	8,999	4.0%			
ξ	Total Net Worth						
Ş	(Including minority interest)	51,581	48,804	5.7%			
	Quarterly EBITDA*	5,872	2,736	114.6%			
	Current Ratio	1.45	1.55				
	Leverage Ratio	0.86	0.93				

\*: EBITDA number has been adjusted for fire loss

# Capital Expenditure v.s. EBITDA





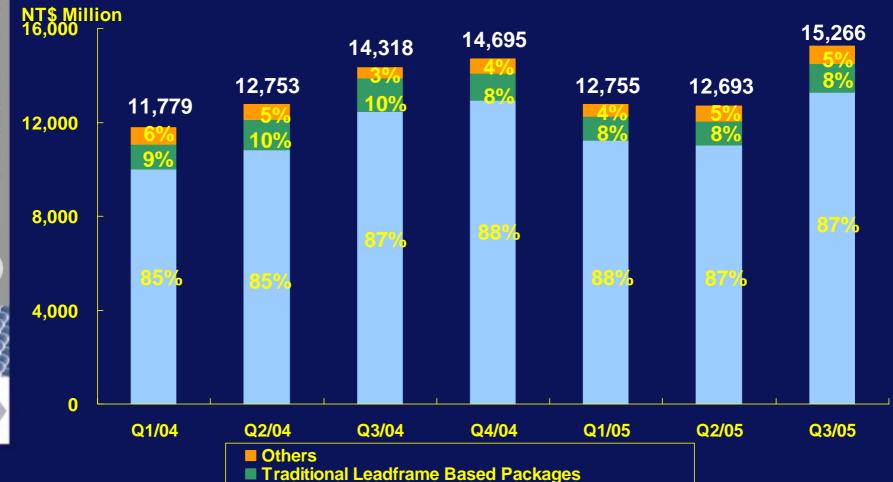
# Consolidated Revenue & Margin Trend



# **IC Packaging Operations**



#### IC Packaging Operations Package Revenue Breakdown



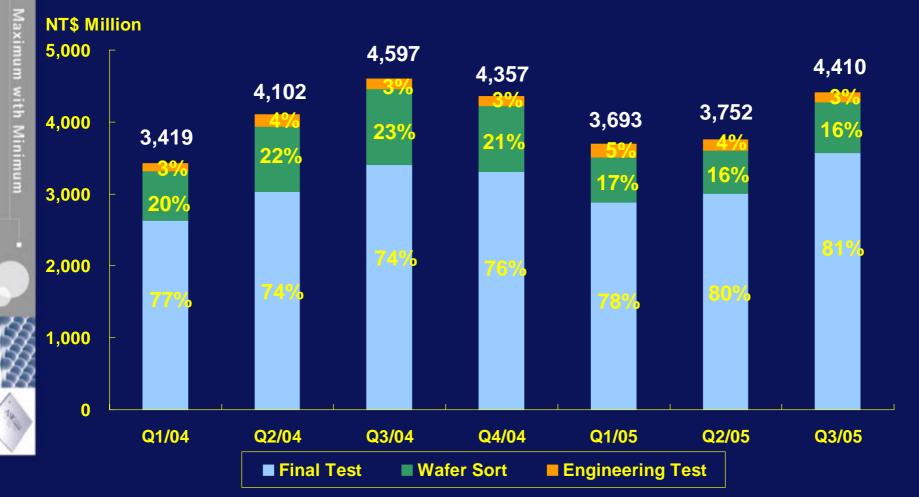
Traditional Leadframe Based Packages
 Advanced Substrate & Leadframe Based Packages

# **Testing Operations**

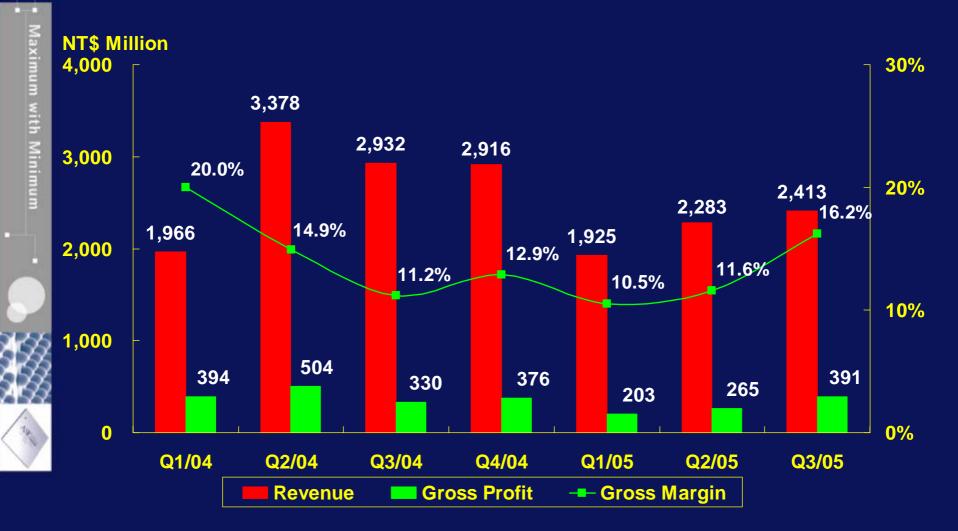




# Test Revenue Breakdown

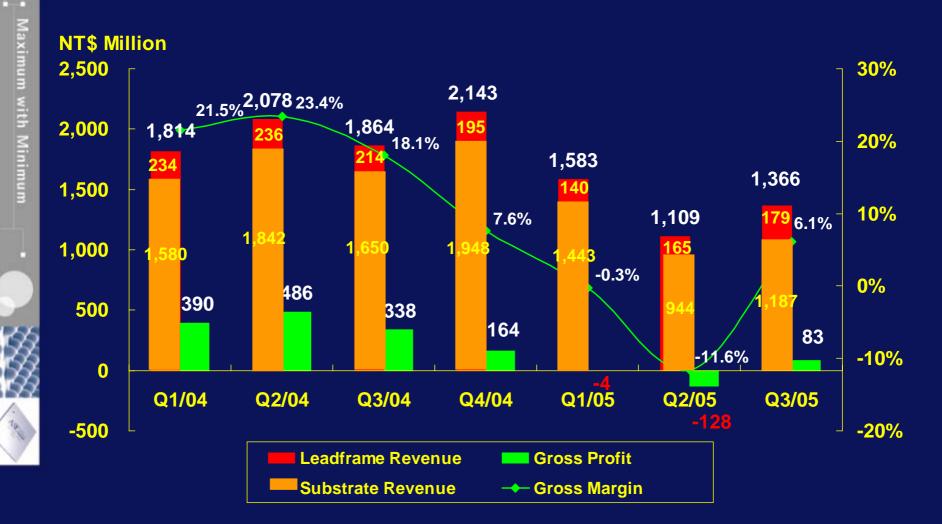






## **Material Operations**









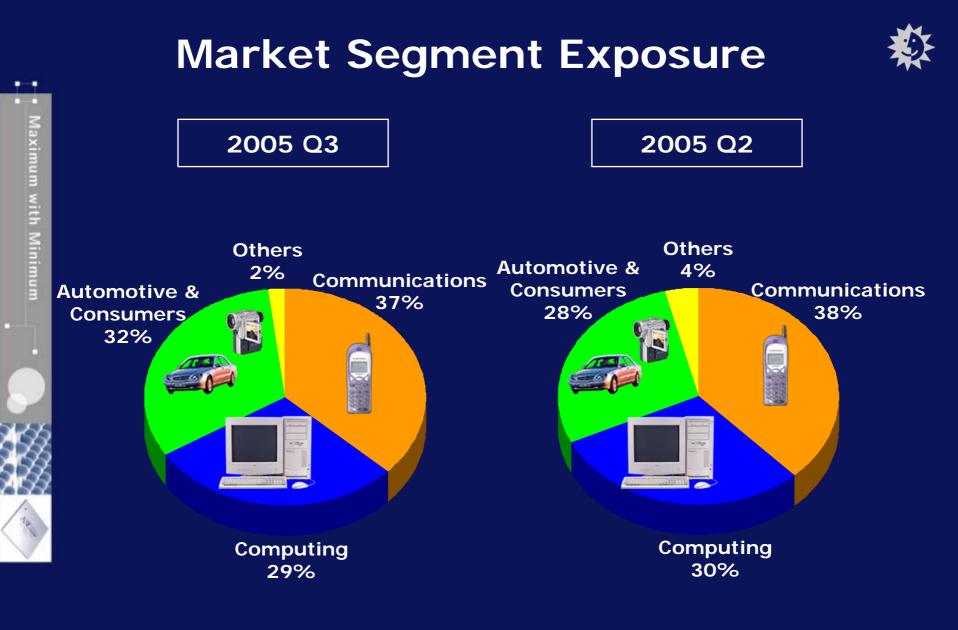
**ASE Group** 

ATI CAMBRIDGE FLEXTRONICS FREESCALE IEE NEC QUALCOMM RFMD STM VIA



31% of Total Sales48% of Total Sales







# Guidance for 2005 Q4

- > Sequential revenue growth: high single digit %
  > Gross margin: above 20%
- >2005 full year Capex: US\$300 Millions

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### For more information regarding ASE Group http://www.aseglobal.com

## For all inquiries, suggestion, and comments ir@aseglobal.com